Electronic Version v1.1

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CONVEYING PARTY DATA					
N			ame	Execution Date	
HEE SUNG SHIM 12/18/2006					
RECEIVING PARTY DATA					
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City:	SEOUL				
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PROPERTY NUMBERS Total: 1 Property Type Application Number: 11612		612	Number		
Application Number: 11612598					
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ATTORNEY DOCKET NUMBER:			SUN-DE-237		
NAME OF SUBMITTER:		JEFFLLOYD			
Total Attachments: 2 source=Assignment-FINAL#page1.tif source=Assignment-FINAL#page2.tif					

ASSIGNMENT

WHEREAS, I, the undersigned, residing at the indicated address given below, respectively, am the inventor of the invention described in a patent application entitled, **METHOD FOR MANUFACTURING CMOS IMAGE SENSOR**, filed on December 19, 2006, as Serial No. <u>11/612,598</u>, under Attorney Docket No. <u>SUN-</u>DE-237;

WHEREAS, Dongbu Electronics Co., Ltd., a Corporation of the country of the Republic of Korea, having a place of business at <u>891-10</u>, <u>Daechi-dong</u>, <u>Gangnam-gu</u>, <u>Seoul</u>, <u>Korea</u>, <u>135-</u> <u>280</u>, is desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent which may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in view of valuable consideration, receipt of which is hereby acknowledged, I, the undersigned, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer, unto said Dongbu Electronics Co., Ltd., its successors and assigns, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title, and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, and extensions thereof.

I hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to Dongbu Electronics Co., Ltd., as the assignee of the entire right, title, and interest in and to the same, for the sole use and behoof of said Dongbu Electronics Co., Ltd., its successors and assigns.

FURTHER, I agree that I will communicate to said Dongbu Electronics Co., Ltd., or its representatives, any facts known to us respecting said invention; testify in any legal proceedings; sign all lawful papers; execute all divisional, continuation, substitution, renewal, and reissue applications; execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Dongbu Electronics Co., Ltd., make all rightful oaths; and generally do everything possible to aid the said Dongbu Electronics Co., Ltd., its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

I hereby authorize and request my attorney, Jeff Lloyd, of Saliwanchik, Lloyd & Saliwanchik, P.O. Box 142950, Gainesville, Florida 32614-2950, to insert above the application number and filing date of said application when known.

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PATENT REEL: 018795 FRAME: 0021

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IN TESTIMONY WHEREOF, I have bereunto set my hand this ______/8 _____ day of _______, 2006.

(hin Signature:

Name: Address: Hee Sung SHIM 1/3, 801, Gyohang 1-ri, Jumunjin-eup Gangneung-si, Gangwon-do Korea, 210-801

WITNESS: Signature: hee LEE Printed Name: 006 Date:

06-12~18;

Date:

4:54PM;

J:\SUN\DE\237\PTO Misc\Assignment-Shim.doc/DNB/fes

RECORDED: 01/24/2007

PATENT REEL: 018795 FRAME: 0022